



Material Content Data Sheet



Sales Product Name		IPD80R280P7		Issued		20. July 2018		
MA#		MA001456962						
Package		PG-TO252-3-313		Weight*		320.17 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	5.042	1.57	1.57	15747	15747
leadframe	non noble metal	iron	7439-89-6	0.147	0.05		460	
	inorganic material	phosphorus	7723-14-0	0.044	0.01		138	
	non noble metal	copper	7440-50-8	147.096	45.96	46.02	459439	460037
wire	non noble metal	aluminium	7429-90-5	1.814	0.57	0.57	5664	5664
encapsulation	organic material	carbon black	1333-86-4	1.377	0.43		4300	
	plastics	epoxy resin	-	24.091	7.52		75246	
	inorganic material	silicondioxide	60676-86-0	112.196	35.04	42.99	350430	429976
leadfinish	non noble metal	tin	7440-31-5	3.740	1.17	1.17	11682	11682
plating	inorganic material	phosphorus	7723-14-0	0.003	0.00		11	
	non noble metal	nickel	7440-02-0	1.421	0.44	0.44	4437	4448
solder	noble metal	silver	7440-22-4	0.100	0.03		312	
	non noble metal	tin	7440-31-5	0.080	0.02		249	
	non noble metal	lead	7439-92-1	3.813	1.19	1.24	11908	12469
heatspreader	non noble metal	iron	7439-89-6	0.019	0.01		60	
	inorganic material	phosphorus	7723-14-0	0.006	0.00		18	
	non noble metal	copper	7440-50-8	19.177	5.99	6.00	59899	59977
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com